

# Irradiation Experiments for EU-XFEL/TESLA Electronics



The LC cold option

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### Current research:

- Evaluate radiation level in LINAC II and compare to environment expected in EU-XFEL/TESLA
- Determine Single Event Effects (SEEs) in electronics representative for EU-XFEL/TESLA LLRF (SEE in memory: data, configuration and logic)
- Determine radiation impact on different kinds of electronic components
- Develop redundancy concepts and evaluate performance in presence of radiation

### Tasks to perform:

- Determine Total Ionizing Dose (TID) effects
  - measurement of leakage current (supply current to various chips)
  - malfunction of components (permanent damage)
- Carry out fault tolerant software tests in radiation environment
- Predict performance and life-time of electronic components for EU-XFEL/TESLA experiments
- Develop criterions for radiation tolerant hardware

### Radiation effects in semiconductors and radiation dosimetry

High energy neutrons predominantly cause NIEL (displacement) damage as well as Single-Event-Upset (SEU) in semiconductor devices. On the other hand, the damaging effect of photons is many order magnitude less than that caused by neutrons (Figure 1). High flux of Photon-neutrons is produced near the Linac-2 (Figure 2) as well as TTF-2 linac mainly via the Giant-Dipole-Resonance (GDR) process (V.Vylet and J. C. Liu, Radiat. Prot. Dosim. 96(2001)333, W. P. Swanson, Hth. Phys. 35(1978)353). Some typical photon-neutron spectra relevant to present work are shown in Figure 3. We have developed two types of passive devices using: (a) Thermo-Luminescent-Dosimeter (<sup>7</sup>LiF and Al<sub>2</sub>O<sub>3</sub> dosimeter pairs) and (b) Light-Emitting-Diodes (GaAs) to explicitly estimate the neutron and gamma KERMA-doses. The neutron fluence (energy spectrum) and KERMA (Kinetic-Energy-Released-in Matter) coefficients for GaAs (A. M. Ougoug et al. IEEE Trans. NS. 37(1990)2219), Si and <sup>7</sup>LiF (R. S. Caswell et al. Int. J. Appl. Radiat. Isot. 33(1982)1227) were used to calculate neutron KERMA (J kg<sup>-1</sup> = Gy) in the materials of interest (Figure 4) and correlated with corresponding radiation induced damage.

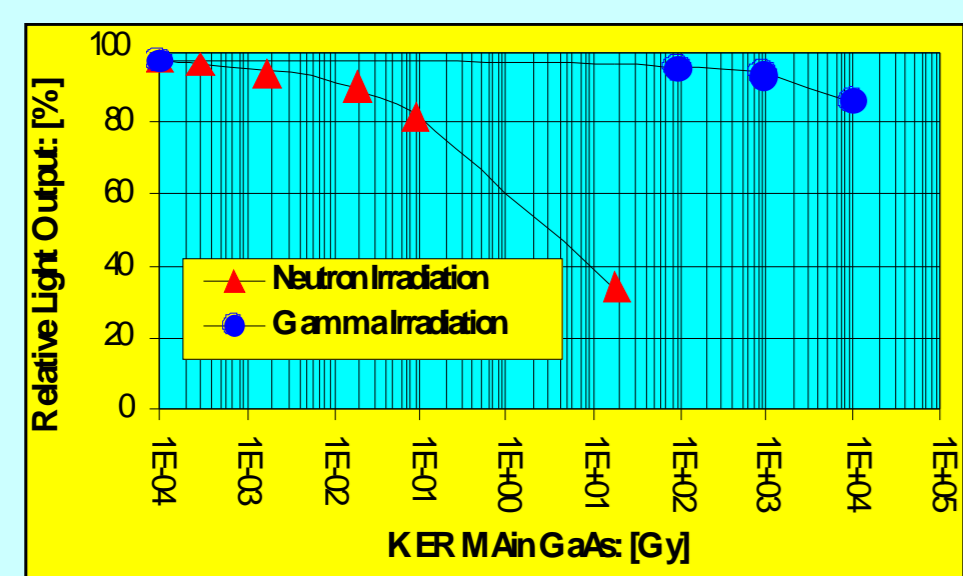


Figure 1: Relative light output of GaAs LED irradiated with <sup>60</sup>Co gamma rays (E<sub>G</sub> = 1.25 MeV) and fast neutrons (E<sub>N</sub> = 16 MeV) from a Medical Cyclotron.

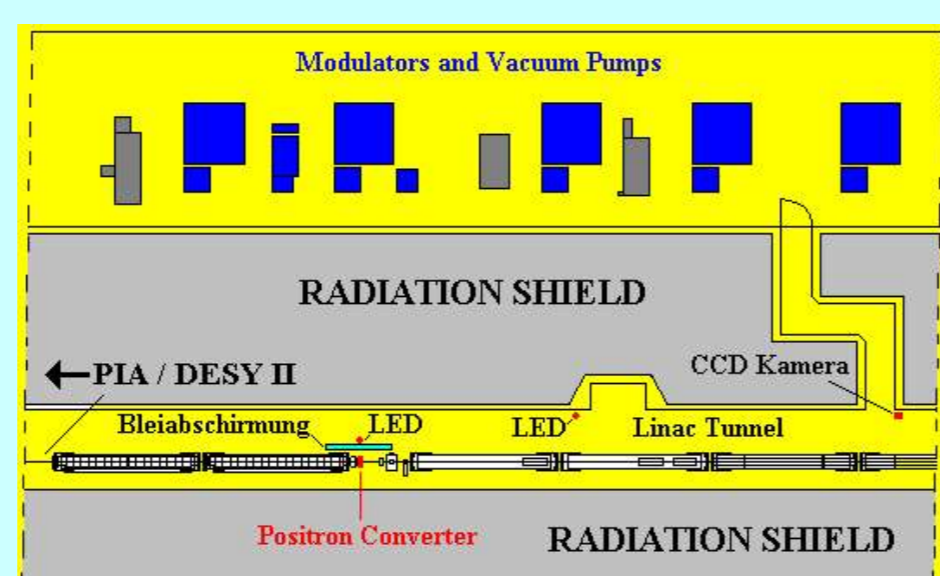


Figure 2: The irradiation set up in the Linac-2 Tunnel.

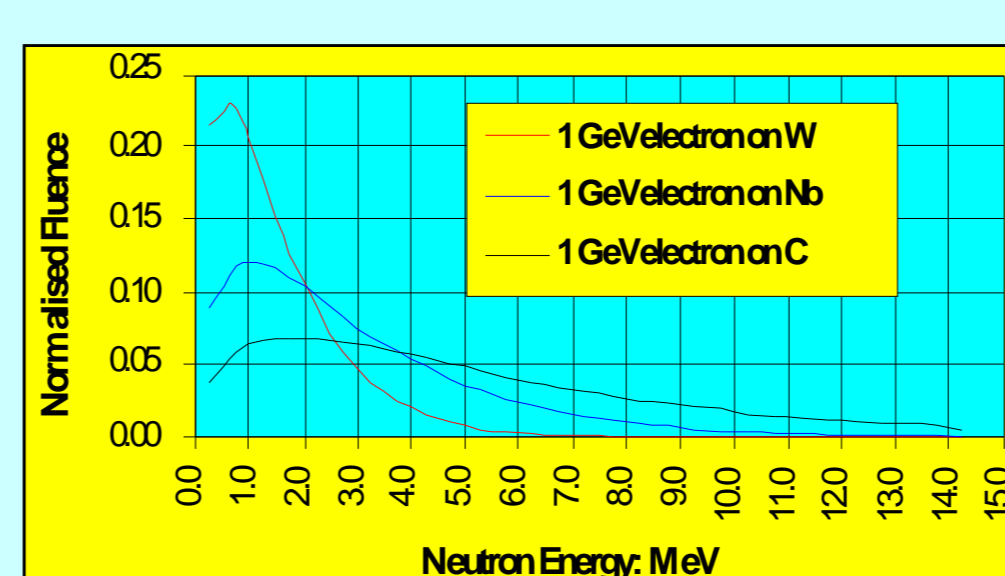


Figure 3: Photon-neutron spectra of 1 GeV electrons produced in some important accelerator building materials.

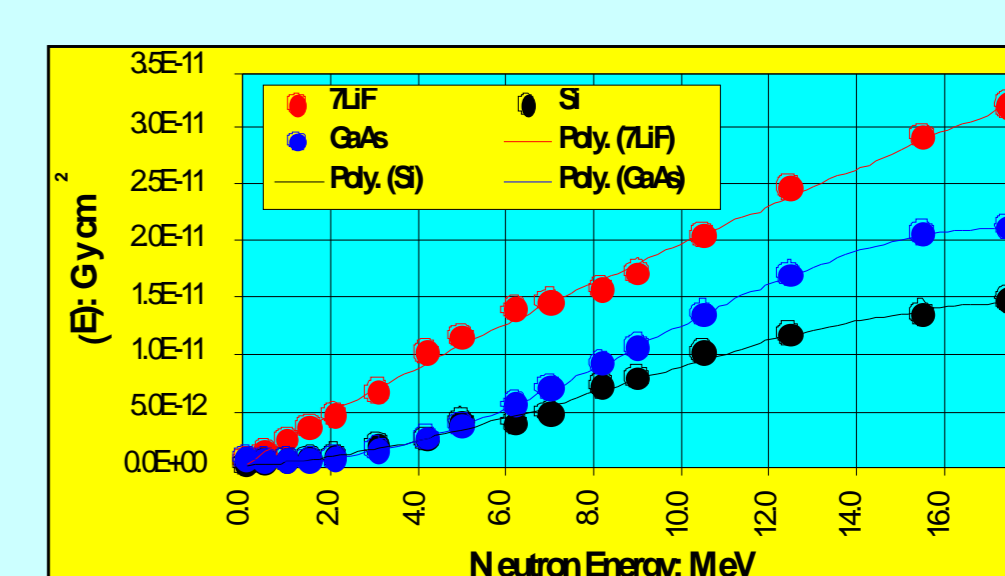


Figure 4: Neutron KERMA coefficient κ(E) is plotted as a function of neutron energy.

### TLD Glow-Curve Analysis

The Al<sub>2</sub>O<sub>3</sub> (TLD-500) dosimeters possess very low sensitivity for neutrons (B. Mukherjee and A. C. Lucas, Radiat. Prot. Dosim. 47(1993)177) and are highly responsive to gamma rays. The Computerised Glow Curve Analysis (Y. Horowitz and D. Yossian, Radiat. Prot. Dosim 60(1995)21) method was used to isolate the high temperature glow peak of the TLD-700 (<sup>7</sup>LiF) dosimeter (B. Mukherjee, Nucl. Instr. Meth. A 385 (1997)179, S. Miljanic et al. Nucl. Instr. Meth. A 519 (2004)667) and correlated with the neutron KERMA in <sup>7</sup>LiF (TLD-700). The results are shown in Figure 5.

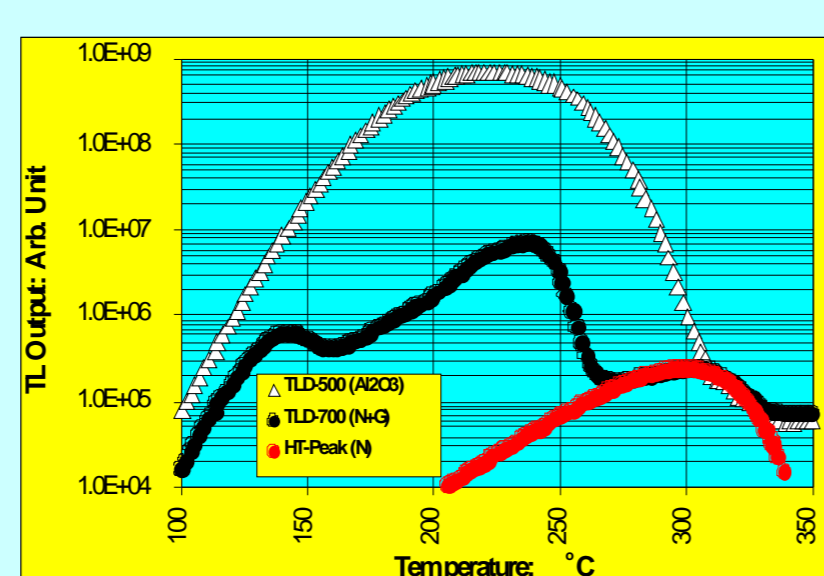


Figure 5: The TL-glow curves of TLD-500 and TLD-700 chips and deconvoluted high-temperature (HT) peak of TLD-700 dosimeter. The area under the HT (300 °C) peak is proportional to neutron dose.

### Calibration of the LED Dosimeter

The Yellow GaAs LEDs were irradiated with high energy neutrons from a Medical Cyclotron (Figure 1). The Light attenuation of the LED (Figure 6) was measured with a digital photometer (Dominik Rybka, M.Sc. Thesis project, under preparation).

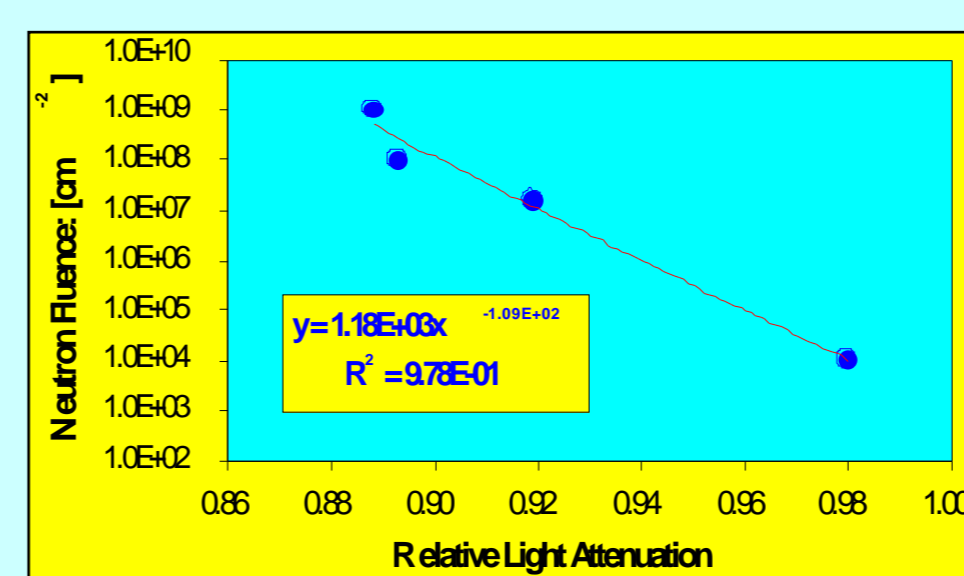


Figure 6: The Calibration curve of the LED dosimeter. The graph is fitted with a power function shown inset.

We have successfully evaluated the neutron KERMA dose in semiconductor components caused by photon-neutrons produced in a thick Tungsten positron generating target. Neutron KERMA was evaluated using the deconvoluted TL-Glow curve (Figure 5) and the light attenuation curve of LEDs (Figure 6). The dosimetry techniques are summarised in the Table 1:

Important features of the Dosimetry methods	Photon-neutron Dosimetry using	
	TLD	LED
Device Sensitivity	High	Low
Read-out method	Indirect	Direct
Cost of the Sensor/Detector	Low	Low
Cost of the read-out Instrument	High	Low

Table 1: Two dosimetry methods developed for the estimation neutron dose produced by the photon-neutrons.

### NIEL (Non-Ionising Energy Loss) and SEE (Single Event Effects) in electronic components in High Energy Neutron/Gamma mixed radiation field

#### On-line memory experiment

##### UT621024 Memory chip

- Capacity: 1 Mbit, organised as 131.072 8-bits words
- Low power CMOS Static Random Access memory chip 5V power supply, all inputs and outputs fully compatible with TTL
- Access time: 70ns,
- Power consumption: 40mA
- Package: 32-pin, 600mil PDIP
- Data retention voltage: min. 2V

#### NVSRAM memory experiment

##### Nonvolatile CMOS Static Random Access Memories were used in the experiment

- 256kB NVSRAM (BQ4014-85, 262.144x8)
- 128kB NVSRAM (BQ4013-70, 131.072x8)
- The memories are equipped with lithium energy source, with 10 years retention time.
- 5V power supply, all inputs and outputs fully compatible with TTL
- Access time: 256kB-85ns and 128kB-70ns
- Power consumption: 256kB-110mA, 128kB-105mA

#### FPGA irradiation experiment

##### Virtex-II LC 1000 Memec Development Kit Configuration memory test

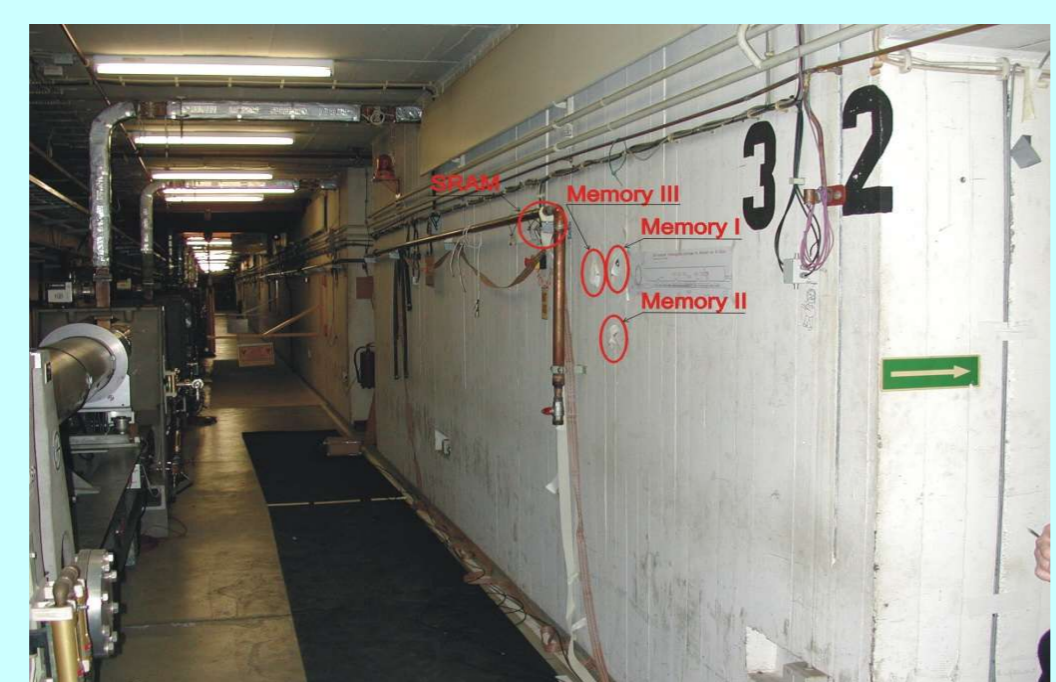
- Based on the Xilinx Virtex-II XC2V1000
- Board placed in Linac II in LED-2 position
- Test: Readback function of configuration memory
- Programming done every 1 hour
- Reading back configuration done every 2 minutes
- JTAG transmission by LVDS standard

#### LED irradiation experiment

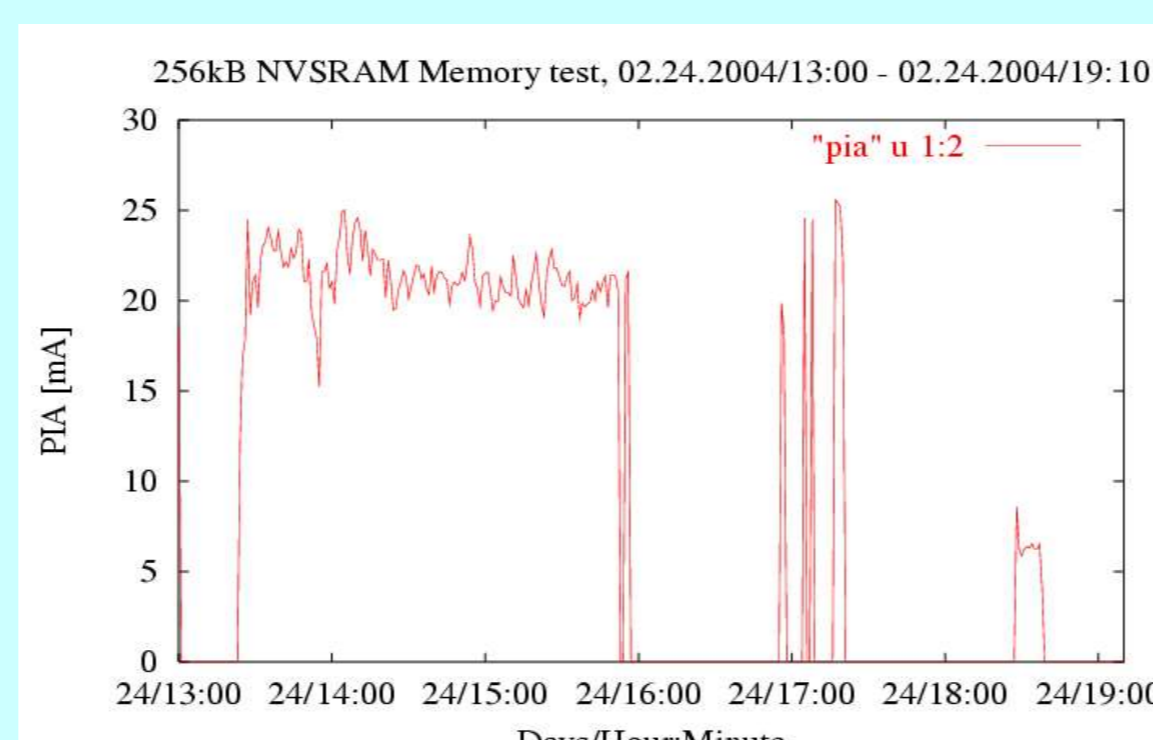
##### PHOTO



1Mbit SRAM and programmer



Memory placement in Linac II chamber



PIA current while experiment

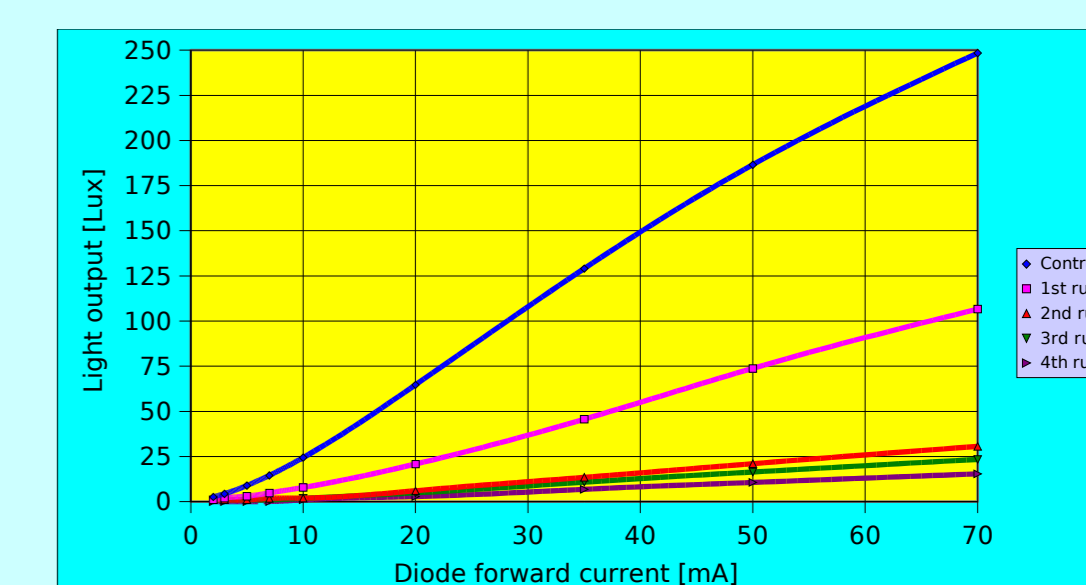


NVSRAM with attached dosimeters

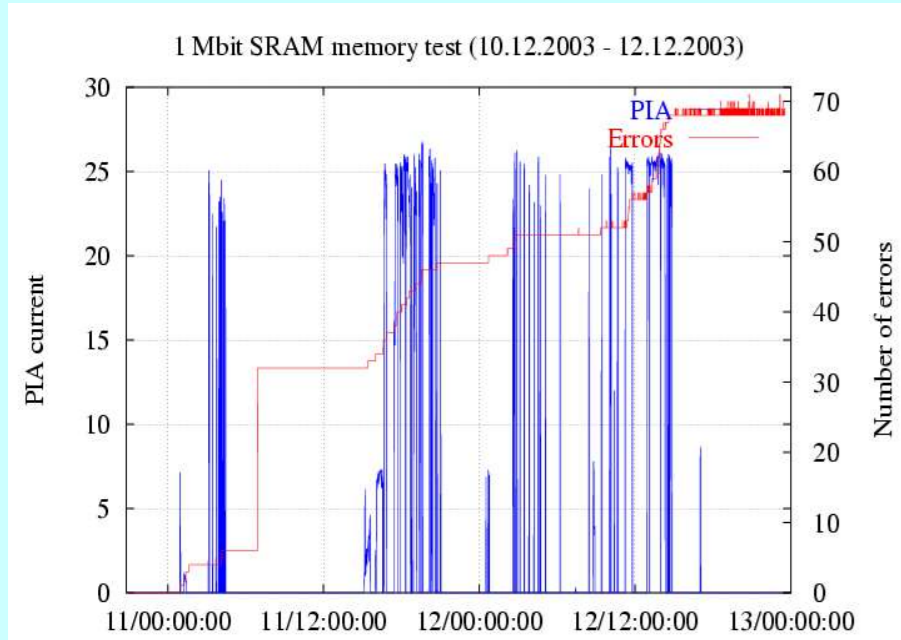


Virtex-II LC 1000 Memec Development Board

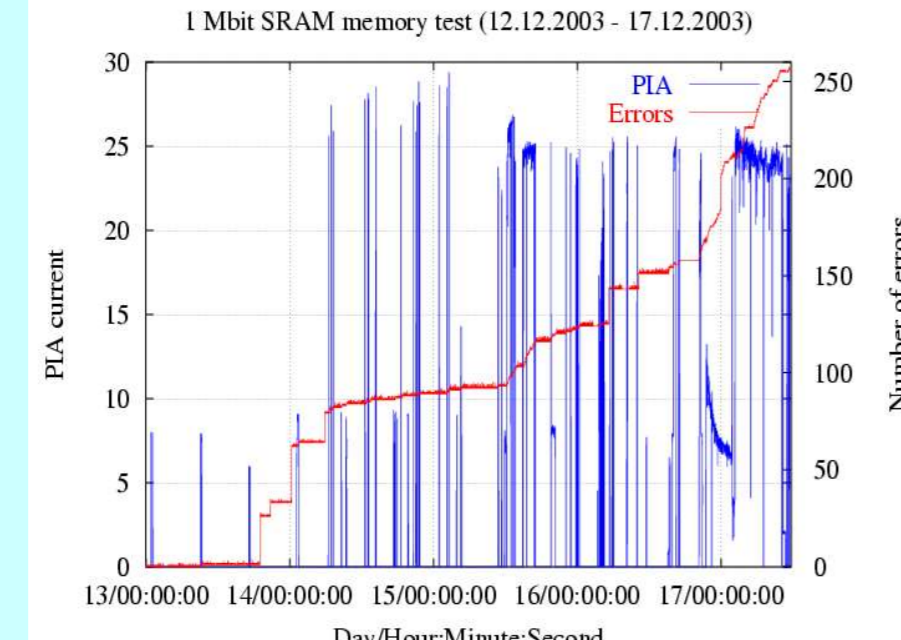
#### Light output measurement apparatus



Average light output of LEDs after irradiation runs (postion LED-1)



Number of errors and PIA current



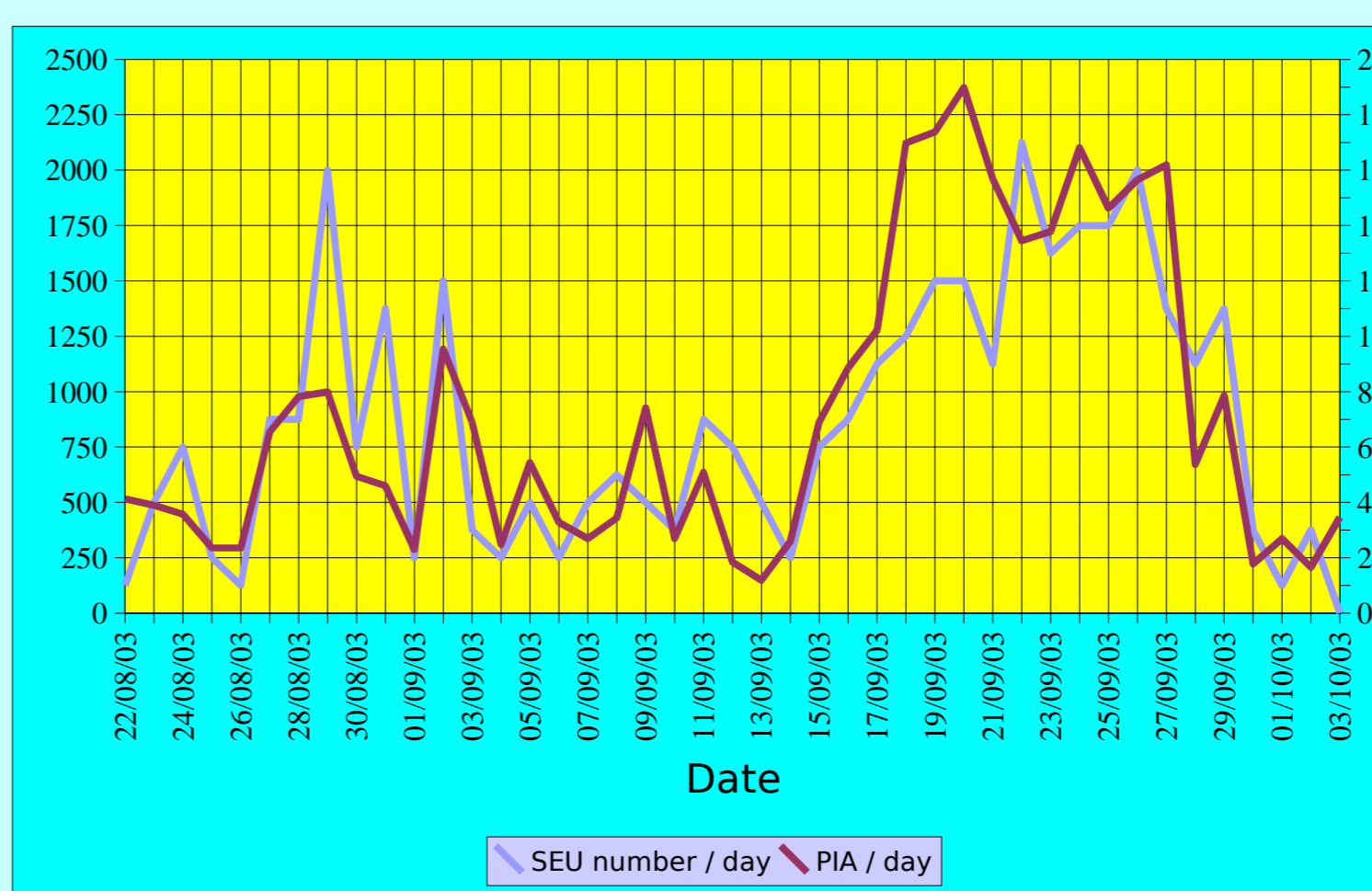
Number of errors and PIA current

Date	PIA	Time	Errors	Errors/day	PIA/error
10.12-12.12.03	618	51	68	32	9
12.12-17.12.03	1743	108	257	57	7
17.12-04.01.04	2523	432	254	14	10
10.01-02.08.04	6343	698	696	24	9

Results obtained for SRAM memory

Irradiation Time	Accumulated PIA Charge	N-KERMA in LiF (mGy)	N-KERMA in Si (mGy)	SRAM Error (SEU)
13.10 - 16.50	246	20.2	7.8	198 (256KB)
13.10 - 19.15	266	21.8	8.4	285 (256KB)
13.10 - 19.15	266	21.8	8.4	161 (128KB)

Number of NVSRAM errors related to the accumulated PIA. Charge and Neutron KERMA in <sup>7</sup>LiF and Si.



Number of errors vs PIA accumulated current

Irradiation run	24.07.03@ 16:47-20:07.03@ 14:00	04.08.03@ 16:40-11.08.03@ 11:50	11.08.03@ 12:02-16.08.03@ 10:37	18.08.03@ 16:43-22.08.03@ 13:15	Light output [Lux]	Relative light attenuation	Accumulated PIA
control					64.64	1.00	0.00
1 <sup>st</sup> run	x				20.80	0.32	792.89
2 <sup>nd</sup> run	x	x			6.00	0.09	6824.42
3 <sup>rd</sup> run	x	x	x		4.80	0.07	9000.60
4 <sup>th</sup> run	x	x	x	x	2.80	0.04	12566.65

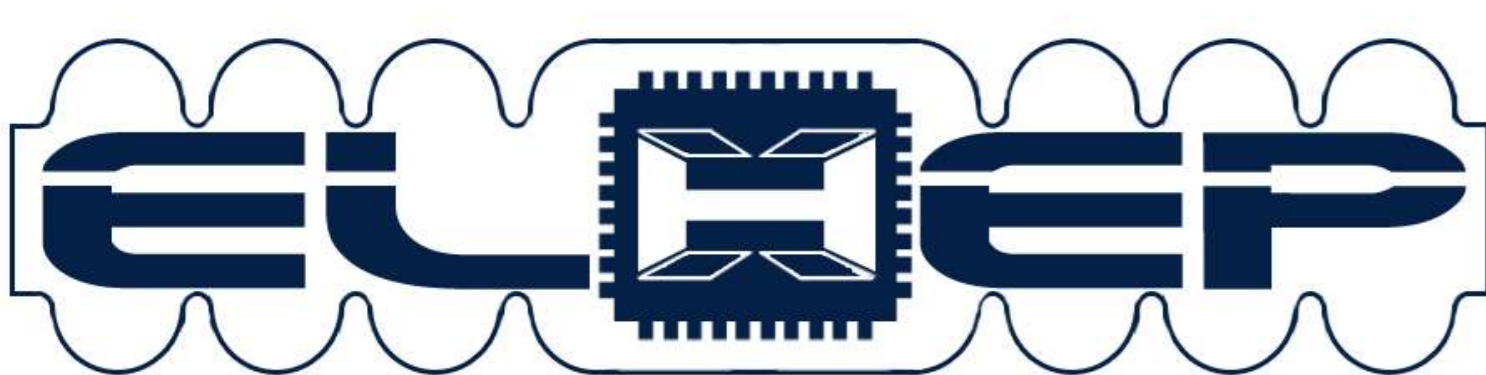
LEDs irradiation runs results

### Conclusions

- Number of generated errors is proportional to Accumulated PIA current
- Only one-bit errors were generated
- Gamma rays have no damage producing effects (SEU) in SRAM.
- No SEL (Single Event LatchUp) was detected

### Conclusions

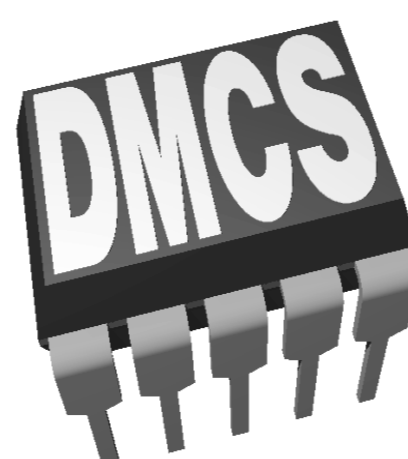
- Possibility of using Light Emitting Diodes as a neutron detector proved.
- Number of static errors is proportional to Accumulated PIA current.
- Dynamic SEUs in configuration memory caused mainly by neutrons.
- Number of errors in FPGAs not very big, but radiation-hardened FPGA projects are needed



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